



Description

The HXY4403S uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.



SOP-8

$V_{DS} = -30V$ $I_D = -6A$

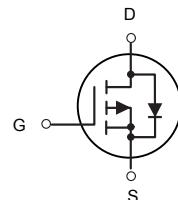
$R_{DS(ON)} < 48m\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply



P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HXY4403S	SOP-8	4403 XXXX	3000

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	- 30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_A=25^\circ C$	Drain Current ³ , $V_{GS} @ 10V$	-6	A
IDM	Pulsed Drain Current ¹	-30	A
$P_D@T_A=25^\circ C$	Total Power Dissipation	3.1	W
	Linear Derating Factor	0.02	W/ $^\circ C$
TSTG	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	40	$^\circ C/W$

Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	$I_D = -250 \mu\text{A}, V_{GS} = 0\text{V}$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -30\text{V}, V_{GS} = 0\text{V}$			-1	uA
		$V_{DS} = -30\text{V}, V_{GS} = 0\text{V}, T_J = 55^\circ\text{C}$			-5	
Gate-Body leakage current	I_{GSS}	$V_{DS} = 0\text{V}, V_{GS} = \pm 12\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-0.5		-1.3	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -10\text{V}, I_D = -6\text{A}$			48	mΩ
		$V_{GS} = -10\text{V}, I_D = -6\text{A}, T_J = 125^\circ\text{C}$			72	
		$V_{GS} = -4.5\text{V}, I_D = -4\text{A}$			57	
		$V_{GS} = -2.5\text{V}, I_D = -2\text{A}$			80	
On state drain current	$I_{D(on)}$	$V_{GS} = -4.5\text{V}, V_{DS} = -5\text{V}$	-30			A
Forward Transconductance	g_{FS}	$V_{DS} = -5\text{V}, I_D = -6\text{A}$		19		S
Input Capacitance	C_{iss}	$V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$		645	780	pF
Output Capacitance	C_{oss}			80		
Reverse Transfer Capacitance	C_{rss}			55		
Gate resistance	R_g	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$	4		12	Ω
Total Gate Charge	Q_g	$V_{GS} = -4.5\text{V}, V_{DS} = -15\text{V}, I_D = -6\text{A}$		7		nC
Gate Source Charge	Q_{gs}			1.5		
Gate Drain Charge	Q_{gd}			2.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = -10\text{V}, V_{DS} = -15\text{V}, R_L = 2.5\Omega, R_{GEN} = 6\Omega$		6.5		ns
Turn-On Rise Time	t_r			3.5		
Turn-Off Delay Time	$t_{d(off)}$			41		
Turn-Off Fall Time	t_f			9		
Body Diode Reverse Recovery Time	t_{rr}	$I_F = -6\text{A}, dI/dt = 100\text{A/us}$		11		nC
Body Diode Reverse Recovery Charge	Q_{rr}			3.5		
Maximum Body-Diode Continuous Current	I_S				-3.5	A
Diode Forward Voltage	V_{SD}	$I_S = -1\text{A}, V_{GS} = 0\text{V}$			-1	V

Note : The static characteristics in Figures 1 to 6 are obtained using $<300 \mu\text{s}$ pulses, duty cycle 0.5% max.



Typical Characteristics

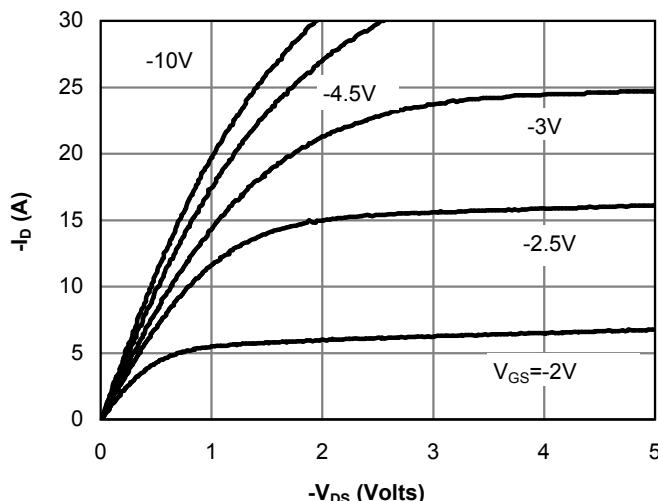


Fig 1: On-Region Characteristics (Note E)

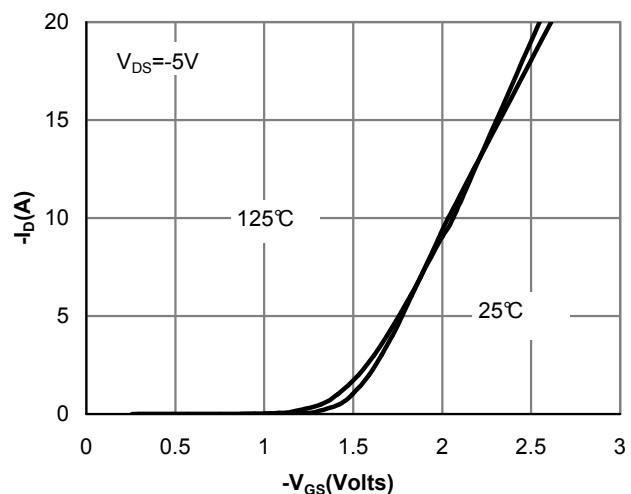


Figure 2: Transfer Characteristics (Note E)

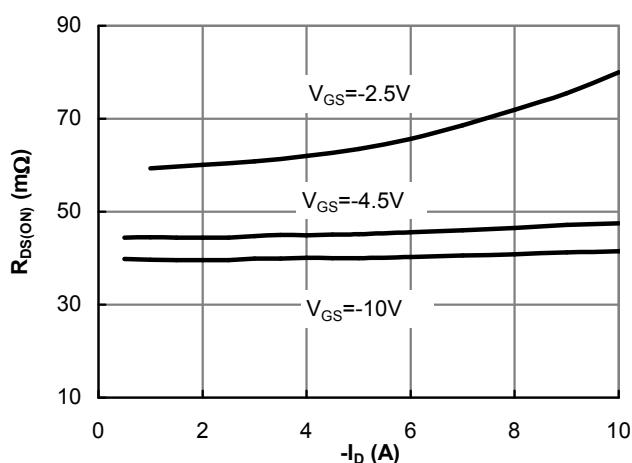


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

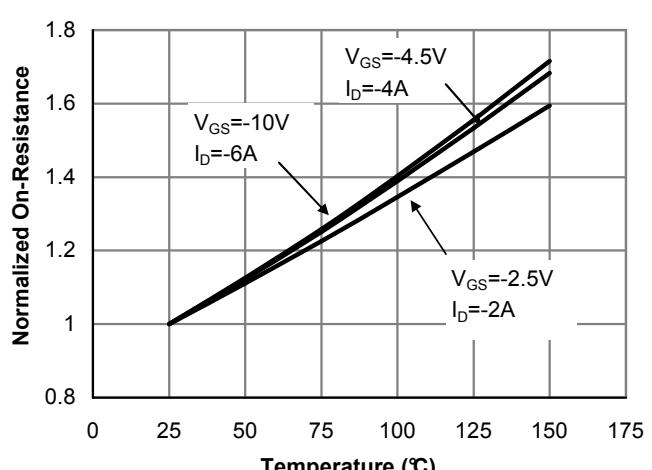


Figure 4: On-Resistance vs. Junction Temperature

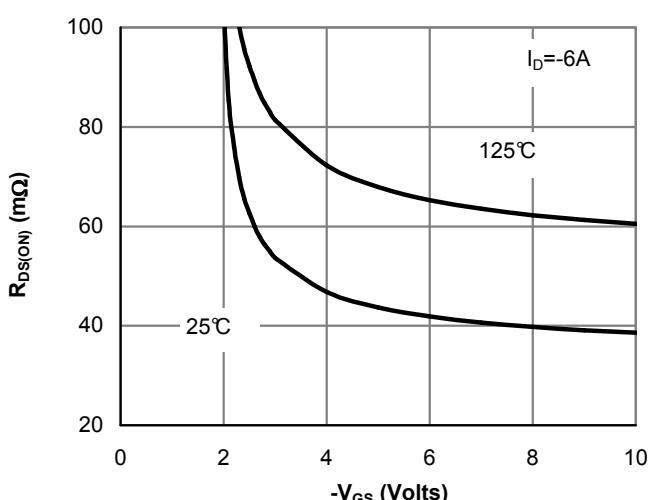


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

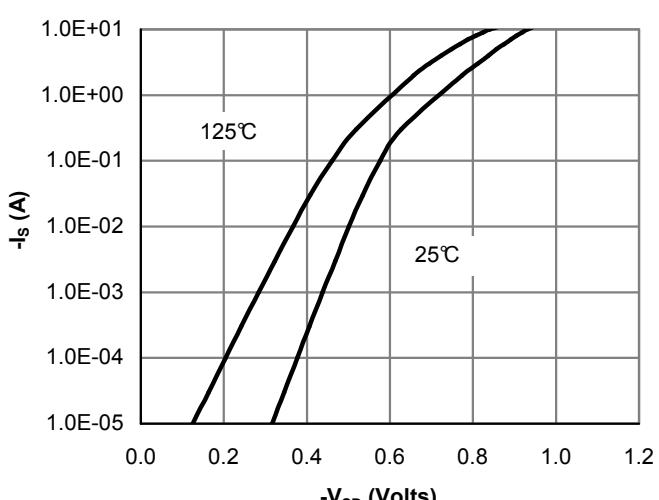
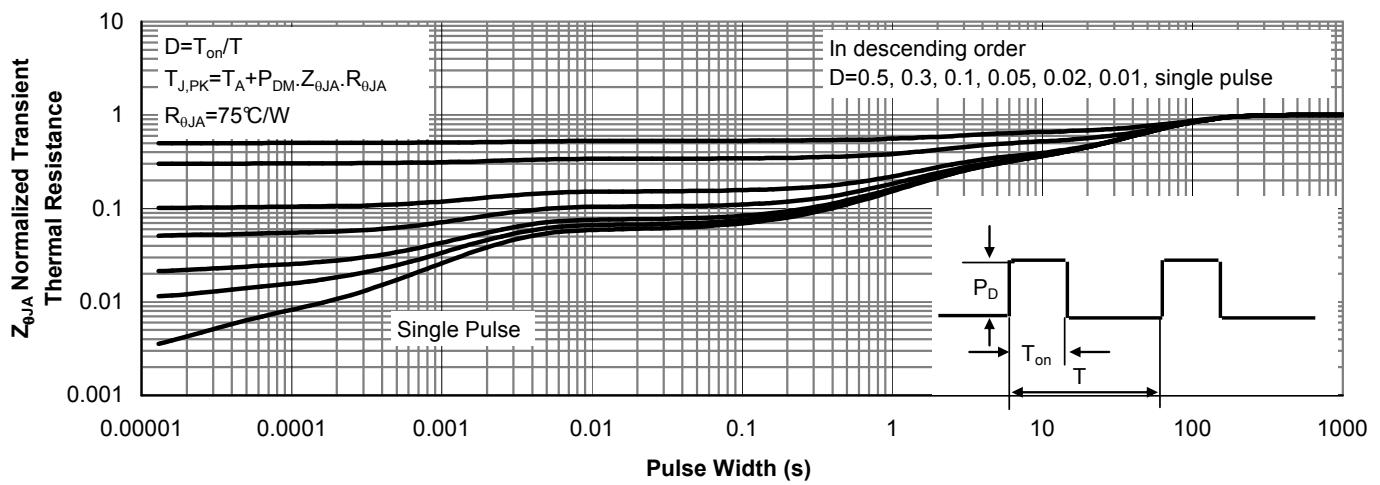
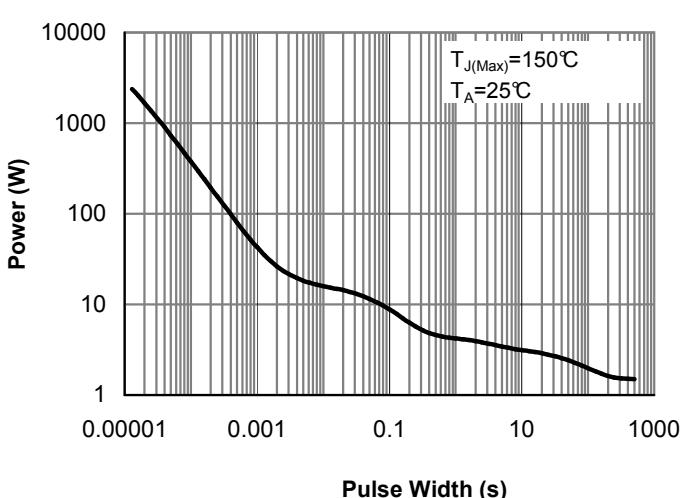
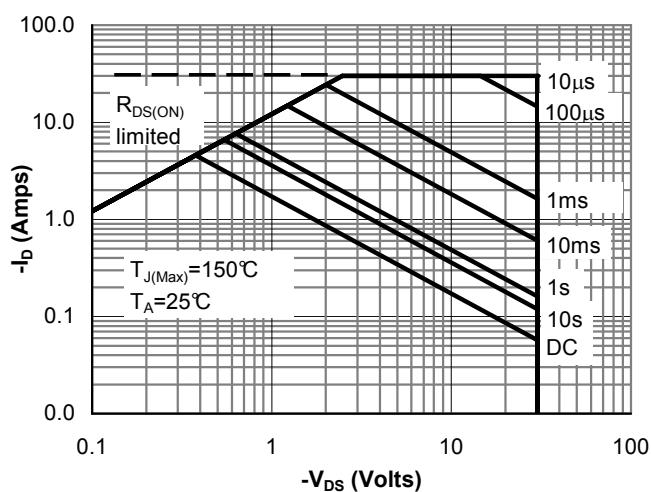
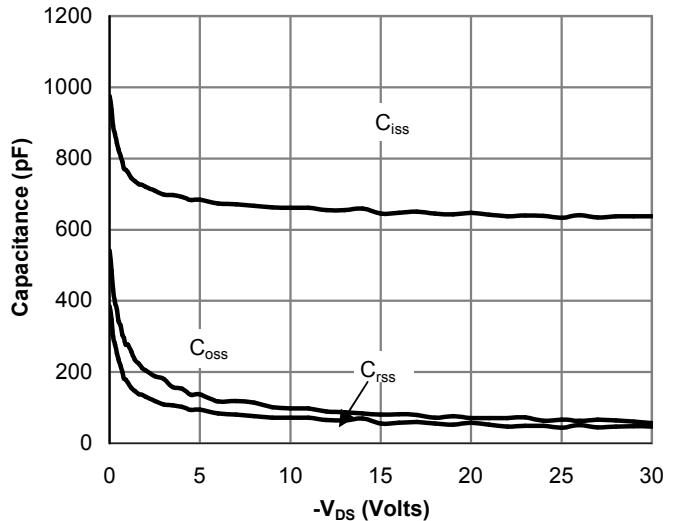
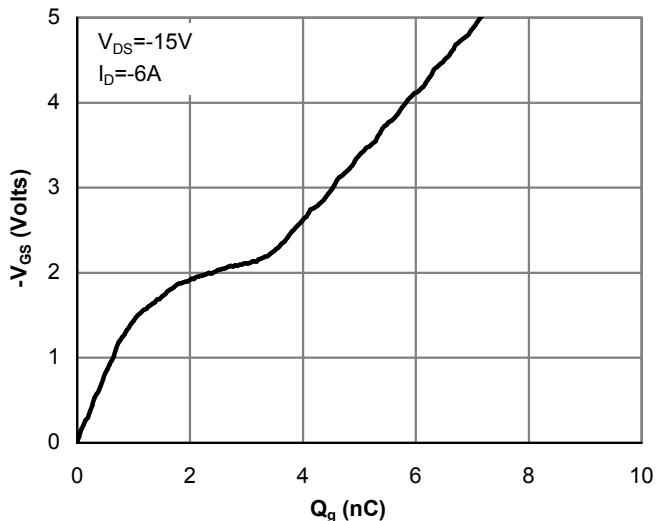


Figure 6: Body-Diode Characteristics (Note E)

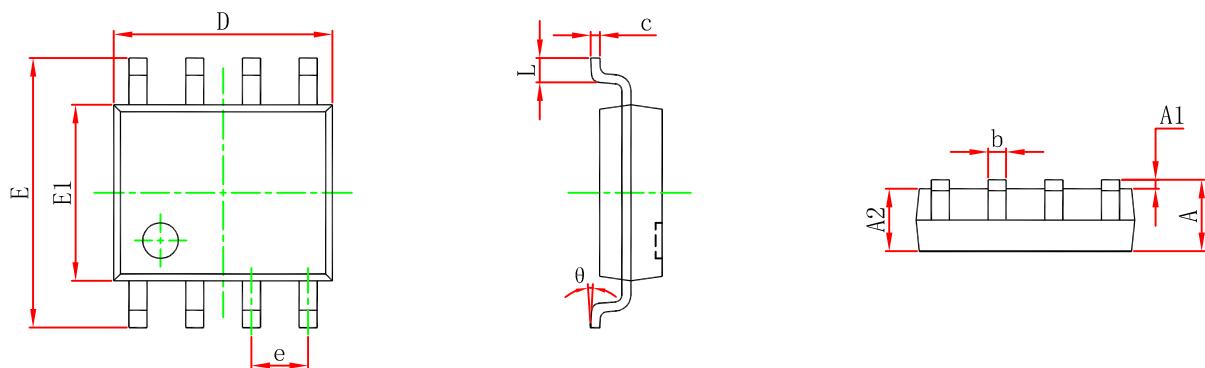


Typical Characteristics

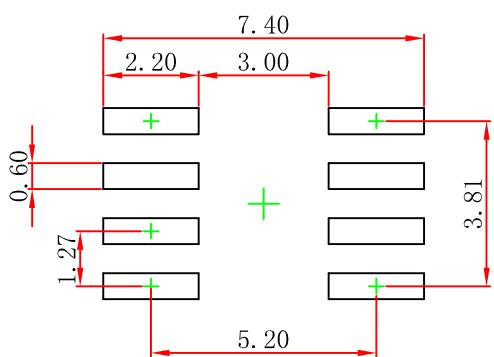




SOP-8 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270 (BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°



Note:
1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.



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